

# FDS9431A-F085

## P-Channel 2.5V Specified MOSFET

### **General Description**

This P-Channel 2.5V specified MOSFET is produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize onstate resistance and yet maintain superior switching performance.

# • DC/DC converter

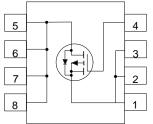
- Power management
- Load switch
- Battery protection

### Features

• -3.5 A, -20 V.  $R_{DS(ON)} = 0.130 \ \Omega \ @ V_{GS} = -4.5 \ V$  $R_{DS(ON)} = 0.180 \ \Omega \ @ V_{GS} = -2.5 \ V.$ 

- Fast switching speed.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability.
- Qualified to AEC Q101
- RoHS Compliant





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Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
ID	Drain Current - Continuous	(Note 1a)	-3.5	А
	- Pulsed		-18	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
TJ, T <sub>stg</sub>	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C

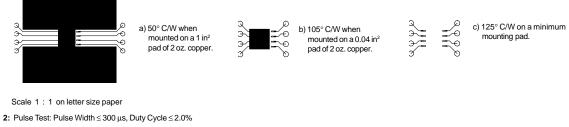
### **Thermal Characteristics**

R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

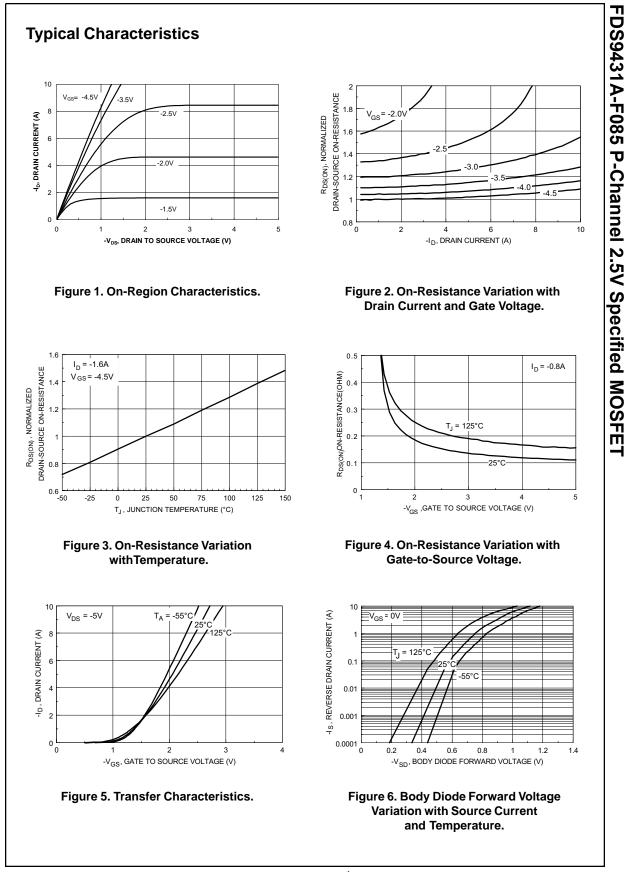
### Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS9431A	FDS9431A-F085	13"	12mm	2500 units

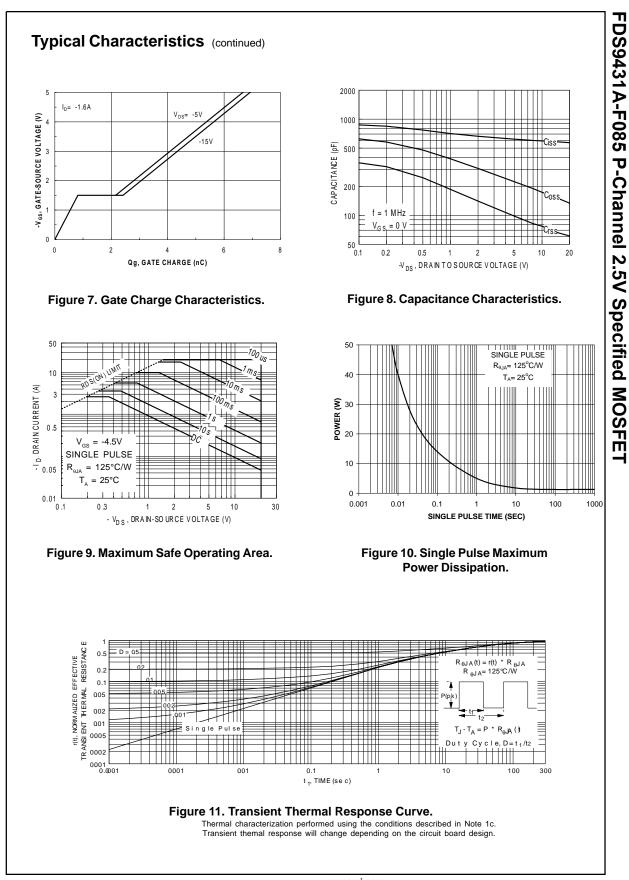
ristics -Source Breakdown Voltage -Source Breakdown Voltage -Source Breakdown Voltage -Source Temperature -Source Temperature -Body Leakage Durrent, -Body Leakage Current, -Source Curr	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ I_D = -250 \ \mu A \\ \\ I_D = -250 \ \mu A, \mbox{Referenced to } 25^\circ \mbox{C} \\ \\ V_{DS} = -16 \ V, \ V_{GS} = 0 \ V \\ \\ V_{GS} = 8 \ V, \ V_{DS} = 0 \ V \\ \\ V_{GS} = -8 \ V, \ V_{DS} = 0 \ V \end{array}$	-20	-28	-1	V mV/°C
-Source Breakdown Voltage kdown Voltage Temperature icient Gate Voltage Drain Current Body Leakage Current, ard Body Leakage Current, rse istics (Note 2)	$I_{D} = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$ $V_{DS} = -16 \ \text{V}, \ V_{GS} = 0 \ \text{V}$ $V_{GS} = 8 \ \text{V}, \ V_{DS} = 0 \ \text{V}$	-20	-28		
Gate Voltage Drain Current Body Leakage Current, ard Body Leakage Current, rse istics (Note 2)	V <sub>DS</sub> = -16 V, V <sub>GS</sub> = 0 V V <sub>GS</sub> = 8 V, V <sub>DS</sub> = 0 V		-28	-1	mV/°C
Body Leakage Current, ard Body Leakage Current, rse istics (Note 2)	$V_{GS} = 8 V, V_{DS} = 0 V$			-1	
ard Body Leakage Current, rse istics (Note 2)					μA
rse (Note 2)	$V_{GS} = -8 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
				-100	nA
Threshold Voltege					
Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-0.4	-0.6	-1	V
Threshold Voltage perature Coefficient	$I_D$ = -250 µA,Referenced to 25°C		2		mV/°C
c Drain-Source esistance	$V_{GS} = -4.5 V, I_D = -3.5 A V_{GS} = -2.5 V, I_D = -3.0 A V_{GS} = -4.5 V, I_D = -3.5 A T_i=125^{\circ}C$		0.110 0.140 0.155	0.130 0.180 0.220	Ω Ω Ω
tate Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-10			A
ard Transconductance	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -3.5 A		6.5		S
Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		405		pF
•	t = 1.0 MHz		170		pF
rse Transfer Capacitance			45		pF
aracteristics (Note 2)					
On Delay Time	$V_{DD} = -5 V, I_D = -1 A,$ $V_{GS} = -4.5 V, R_{GEN} = 6 \Omega$		6.5	13	ns
On Rise Time			20	35	ns
Off Delay Time			31	50	ns
Off Fall Time			21	35	ns
Gate Charge	$V_{DS} = -5 V, I_D = -3.5 A, V_{GS} = -4.5 V$		6	8.5	nC
-Source Charge			0.8		nC
-Drain Charge			1.3		nC
<b>Diode Characteristics a</b>	and Maximum Ratings				
mum Continuous Drain-Source	Diode Forward Current			-2.1	A
	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.7	-1.2	V
	tate Drain Current ard Transconductance racteristics Capacitance ut Capacitance rse Transfer Capacitance aracteristics (Note 2) On Delay Time On Rise Time Off Delay Time Off Fall Time Gate Charge -Drain Charge Diode Characteristics a num Continuous Drain-Source -Source Diode Forward ge	$V_{GS} = -4.5 V, I_D = -3.5 A$ $T_J=125^{\circ}C$ tate Drain Current $V_{GS} = -4.5 V, V_{DS} = -5 V$ ard Transconductance $V_{DS} = -5 V, I_D = -3.5 A$ <b>racteristics</b> Capacitance $V_{DS} = -5 V, I_D = -3.5 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$ $f = 1.0 \text{ MHz}$ $T = 1$	$V_{GS} = -4.5 \text{ V}, I_D = -3.5 \text{ A}$ T_J=125°Ctate Drain Current $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$ ard Transconductance $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}$ racteristicsCapacitance $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$ aracteristics (Note 2)On Delay TimeOn Rise Time $V_{DD} = -5 \text{ V}, I_D = -1 \text{ A}, V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$ Off Fall Time $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}, V_{GS} = -4.5 \text{ V}$ Off Fall Time $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}, V_{GS} = -4.5 \text{ V}$ Diode Characteristics and Maximum Ratingsnum Continuous Drain-Source Diode Forward Current-Source Diode ForwardV_{GS} = 0 \text{ V}, I_S = -2.1 \text{ A} (Note 2)uncton-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the	$V_{GS} = -4.5 \text{ V}, I_D = -3.5 \text{ A}$ $T_J=125^{\circ}\text{C}$ tate Drain Current $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$ -10 ard Transconductance $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A}$ 6.5 <b>racteristics</b> Capacitance $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz 170 rse Transfer Capacitance $V_{DD} = -5 \text{ V}, I_D = -1 \text{ A},$ V_{GS} = -4.5 V, R_{GEN} = 6 \Omega 20 Off Delay Time Off Fall Time Off Fall Time $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A},$ V_{GS} = -4.5 V 0.8 <b>Discret Charge</b> $V_{DS} = -5 \text{ V}, I_D = -3.5 \text{ A},$ $V_{GS} = -4.5 \text{ V},$ $I_D = -3.5 \text{ A},$	$V_{GS} = -4.5 V$ , $I_D = -3.5 A$ 0.155       0.220         tate Drain Current $V_{GS} = -4.5 V$ , $V_{DS} = -5 V$ -10       -10         ard Transconductance $V_{DS} = -5 V$ , $I_D = -3.5 A$ 6.5       -10         racteristics         Capacitance $V_{DS} = -10 V$ , $V_{GS} = 0 V$ , tf = 1.0 MHz       405       -10         aracteristics         Capacitance $V_{DS} = -10 V$ , $V_{GS} = 0 V$ , tf = 1.0 MHz       405       -10         aracteristics (Note 2)         On Delay Time $V_{DD} = -5 V$ , $I_D = -1 A$ , $V_{GS} = -4.5 V$ , $R_{GEN} = 6 \Omega$ 20       35         Off Delay Time $V_{DS} = -5 V$ , $I_D = -3.5 A$ , $V_{GS} = -4.5 V$ 6       8.5         Source Charge $V_{DS} = -5 V$ , $I_D = -3.5 A$ , $V_{GS} = -4.5 V$ 0.8



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